EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	693	(257/685).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:23
L101	478	(257/688).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:23
L103	2429	(257/686).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:24
L104	1888	(257/700).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:25
L105	3902	(257/787).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR ·	OFF	2007/02/20 15:25
L106	656	(257/790).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:37
L107	1850	(257/E23.004).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:37
L108	85	(257/E23.012).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:38
L109	84	(257/E23.016).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:38
L110	777	(257/E23.078).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:49
L12	1718138	flexible folded	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 15:50
L111	3056	(257/678).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 15:50

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L112	13986	101 102 103 104 105 106 107 108 109 110 111	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 15:50
L113	2278672	flex\$1ble fold folded fold\$1ble bend bend\$1ble	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 15:51
L114	326293	wrap wrapped	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2007/02/20 15:51
L115	3259	112 and 113	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 15:52
L116	183	115 and 114	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 15:52
L102	693	(257/685).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/20 17:09
L118	2	(circuit and flexible and thermo\$1plastic and adhesive and wiring and (thin\$3 number)).clm	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 17:11
L117	0	(circuit and flexible and thermo\$1plastic and adhesive and wiring and (thin\$3 number) and bend).clm.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/02/20 17:12
L119	0	(circuit and flexible and thermo\$1plastic and adhesive and wiring and bend).clm.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 17:12
L120	19	(circuit and flexible and thermo\$1plastic and adhesive and wiring).clm.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/20 17:12

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